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**FDMC7660** 

# N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 20 A, 2.2 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 2.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 20 A
- Max  $r_{DS(on)}$  = 3.3 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 18 A
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

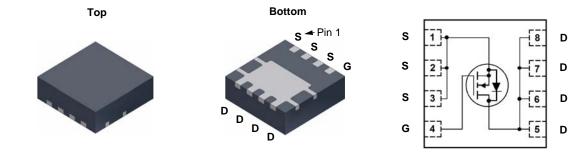


## **General Description**

This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

#### Applications

- DC DC Buck Converters
- Point of Load
- High Efficiency Load Switch and Low Side Switching



Power 33

#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	$T_{C} = 25^{\circ}C$		40		
	-Continuous (Silicon limited)	$T_{C} = 25^{\circ}C$		100		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	20	Α	
	-Pulsed			200		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	200	mJ	
P <sub>D</sub>	Power Dissipation	$T_{C} = 25^{\circ}C$		41		
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.3		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to + 150	°C	

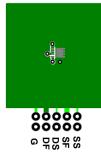
#### **Thermal Characteristics**

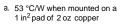
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	a) 53	C/vv

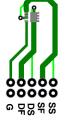
#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7660	FDMC7660	Power 33	13"	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
	octeristics			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{\perp}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C		14		mV/°C	
	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics				1	-	
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.2	1.7	2.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C		-6	-	mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		1.8	2.2	mΩ	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 18 A		2.6	3.3		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125°C		2.2	3.1		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 20 A		163		S	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Characteristics   Input Capacitance Output Capacitance   Reverse Transfer Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1MHz		3630 1345 110	4830 1790 165	pF pF pF	
R <sub>g</sub>	Gate Resistance			0.9		Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			14	25	ns	
r	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 20 A,		6.8	14	ns	
d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		36	58	ns	
f	Fall Time			5.7	11	ns	
д <sup>а</sup>	Total Gate Charge	$V_{GS} = 0$ V to 10 V		54	86	nC	
ට <sup>g</sup>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		24	38	nC	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 20 A		11		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.6		nC	
Drain-Sou	urce Diode Characteristics						
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 20 A (Note 2)		0.8	1.2	V	
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.9 A$ (Note 2)		0.7	1.2		
rr	Reverse Recovery Time			45	63	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 20 A, di/dt = 100 A/μs		25	35	nC	

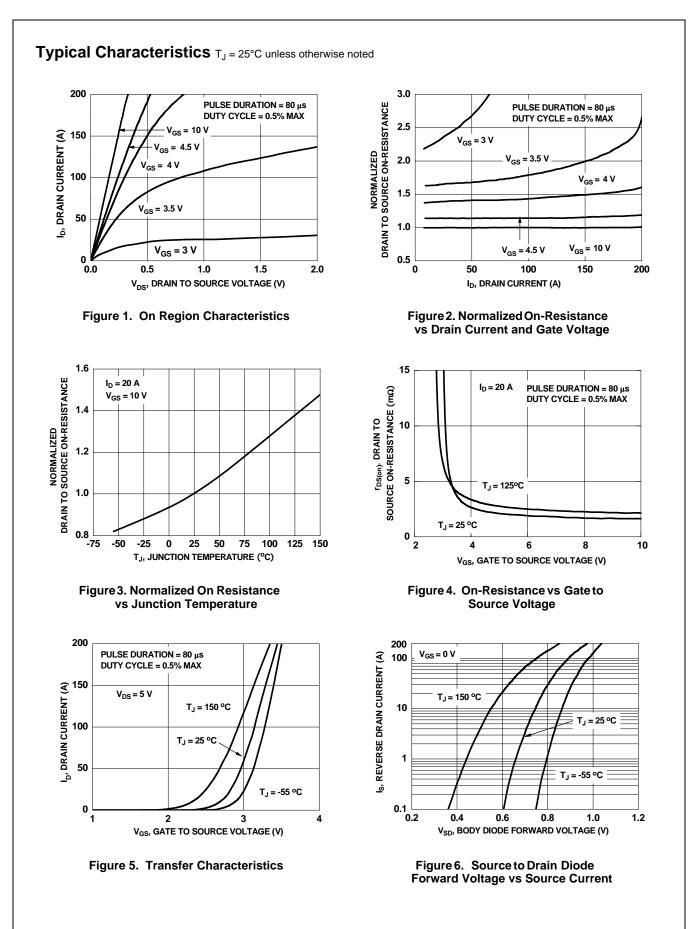






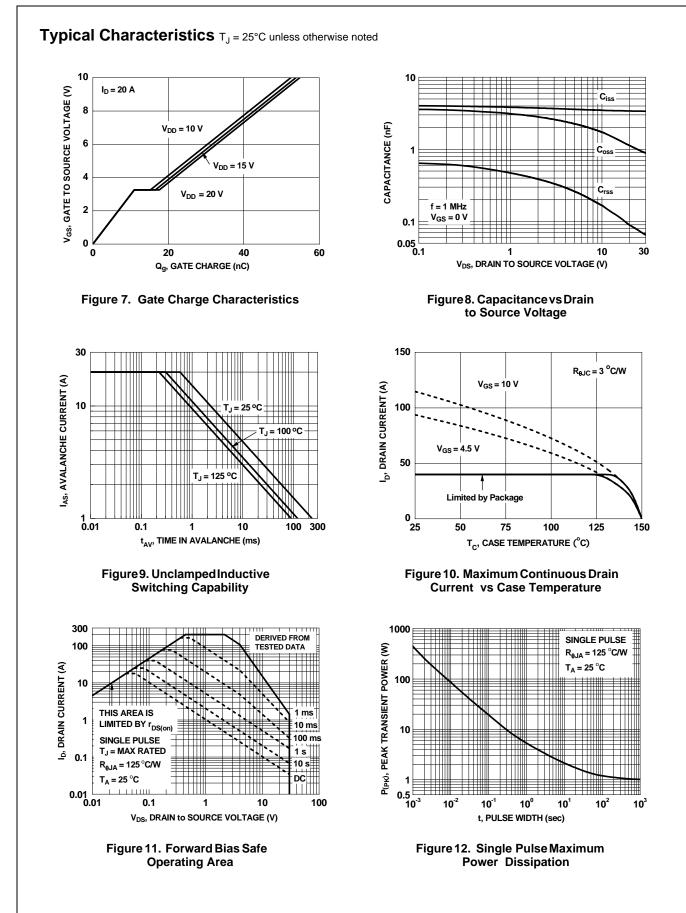
b. 125 °C/W when mounted on a minimum pad of 2 oz copper

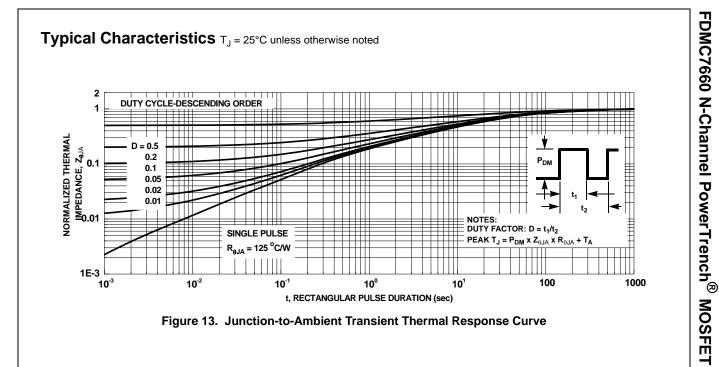
2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. 3. Starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 20 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V 4. As an N-channel device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

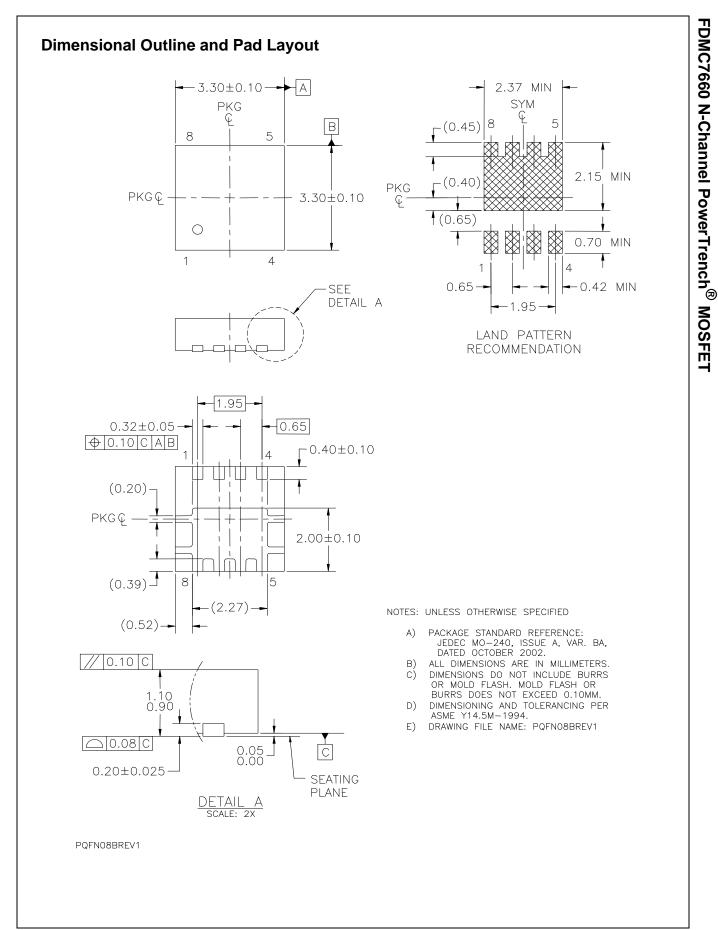


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